TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ( $\pi$ -MOSV)

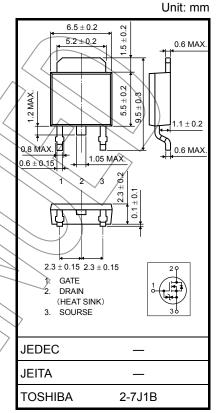
# 2SK2493

Chopper Regulator and DC-DC Converter Applications

- 2.5-V gate drive
- Low drain-source ON resistance :  $R_{DS (ON)} = 0.08 \text{ m}\Omega (typ.)$
- High forward transfer admittance : |Y<sub>fs</sub>| = 8.0 S (typ.)
- Low leakage current : I<sub>DSS</sub> = 100 μA (max) (V<sub>DS</sub> = 16 V)
- Enhancement mode :  $V_{th}$  = 0.5 to 1.1 V ( $V_{DS}$  = 10 V,  $I_D$  = 1 mA)

#### Absolute Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit
Drain-source voltage		V <sub>DSS</sub>	16	X )
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	16	V
Gate-source voltage		V <sub>GSS</sub>	±8	V
Drain current	DC (Note 1)	۱ <sub>D</sub>	5	A
	Pulse (Note 1)	I <sub>DP</sub>	20	A
Drain power dissipation (Tc = 25°C)		PD <	20	w
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C



Note: Using continuously under heavy loads (e.g. the application of high

temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even

Weight: 0.36 g (typ.)

if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling

Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	6.25	°C / W
Thermal resistance, channel to ambient	R <sub>th (ch−a)</sub>	125	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

This transistor is an electrostatic-sensitive device. Please handle with caution.

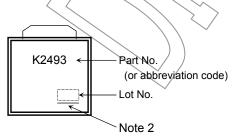
**Electrical Characteristics (Ta = 25°C)** 

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I <sub>GSS</sub>	$V_{GS}$ = ±6.5 V, $V_{DS}$ = 0 V	_	_	±10	μA
Drain cut-off cu	rrent	IDSS	V <sub>DS</sub> = 16 V, V <sub>GS</sub> = 0 V	_	_	100	μA
Drain-source b	reakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	16	_	_	V
Gate threshold	voltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	0.5	-	1.1	V
Drain-source ON resistance		R <sub>DS (ON)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 2.5 A		0.08	0.12	Ω
			V <sub>GS</sub> = 4 V, I <sub>D</sub> = 2.5 A	$\leq$	0.07	0.1	12
Forward transfe	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 2.5 A	4.0	8.0	$\mathcal{F}$	S
Input capacitance		C <sub>iss</sub>		$\overline{\}$	1200		
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	/-/	110	$\langle - \rangle$	pF
Output capacitance		Coss		$\langle \langle \rangle$	380	>-	
Switching time	Rise time	tr	$V_{\rm GS} \stackrel{5V}{}_{\rm OV} \prod \stackrel{I_{\rm D}=2.5A}{}_{\rm V_{\rm OUT}}$	V	30	_	
	Turn-on time	t <sub>on</sub>	$\begin{array}{c} 000  001  0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0 \\ 0$		50	_	20
	Fall time	t <sub>f</sub>	Not the o		200	_	ns
	Turn-off time	t <sub>off</sub>	$V_{DD} = 8V$ Duty $\leq 1\%$ , $t_W = 10\mu s$	-	650	_	
Total gate charg plus gate-drain)	je (Gate-source	Qg		_	23	_	
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx 16 V$ , $V_{GS} = 5 V$ , $D = 5 A$	_	17	—	nC
Gate-drain ("miller") charge		Q <sub>gd</sub>		_	6	—	

## Source–Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	IDR	-		_	5	А
Pulse drain reverse current	IDRP	-	Ι		20	A
Forward voltage (diode)	VDSF	I <sub>DR</sub> = 5 A, V <sub>GS</sub> = 0 V	_		-1.7	V
Reverse recovery time	tr	T <sub>DR</sub> = 5 A, V <sub>GS</sub> = 0 V	_	120		ns
Reverse recovery charge	Qrr	dl <sub>DR</sub> / dt = 50 A μs		0.12	_	μC

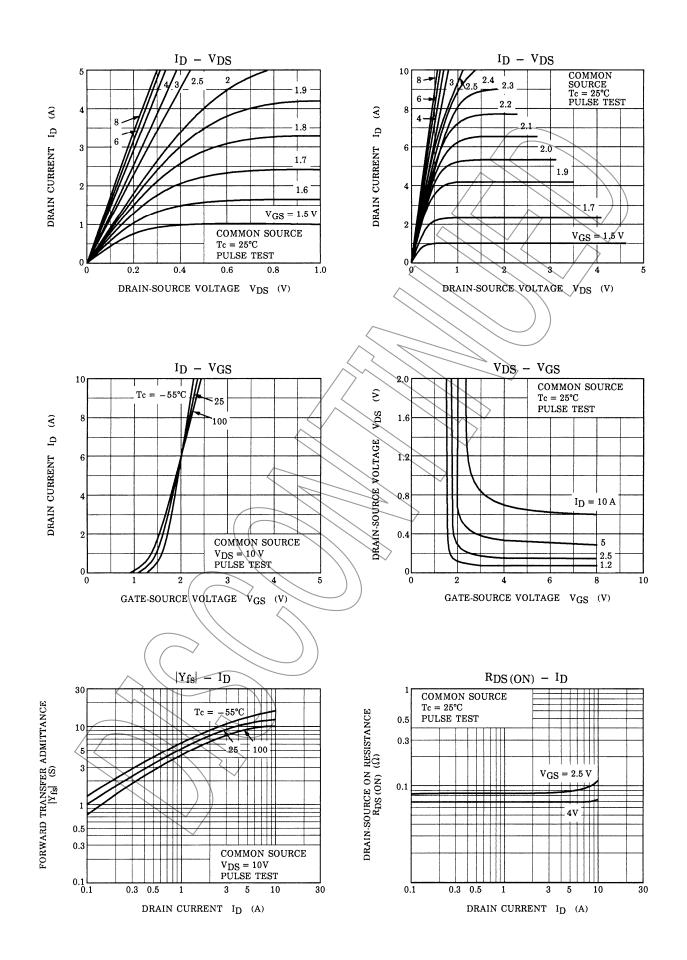
Marking



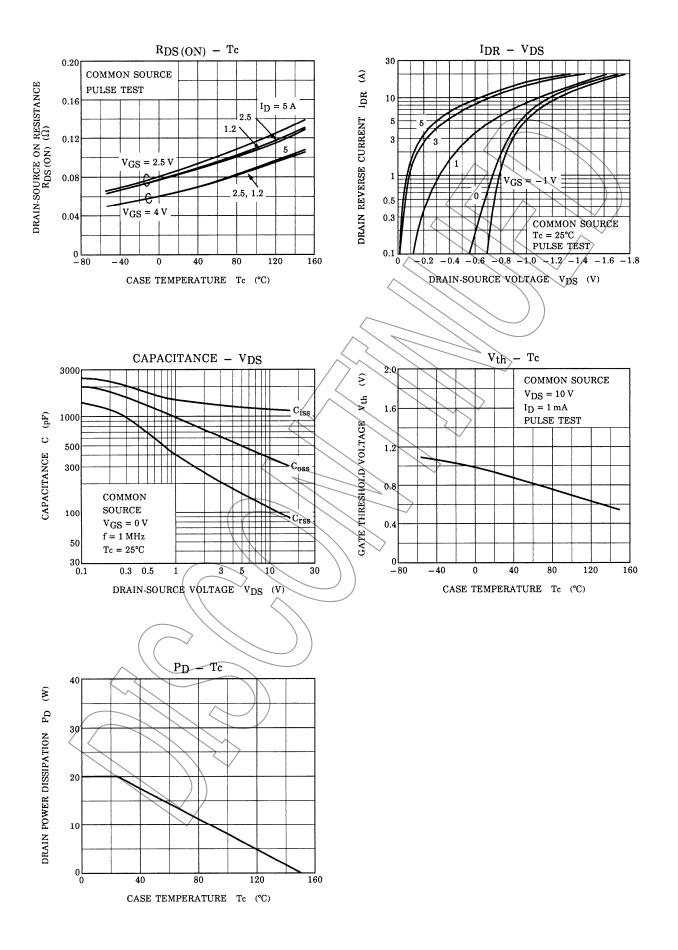
Note 2 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

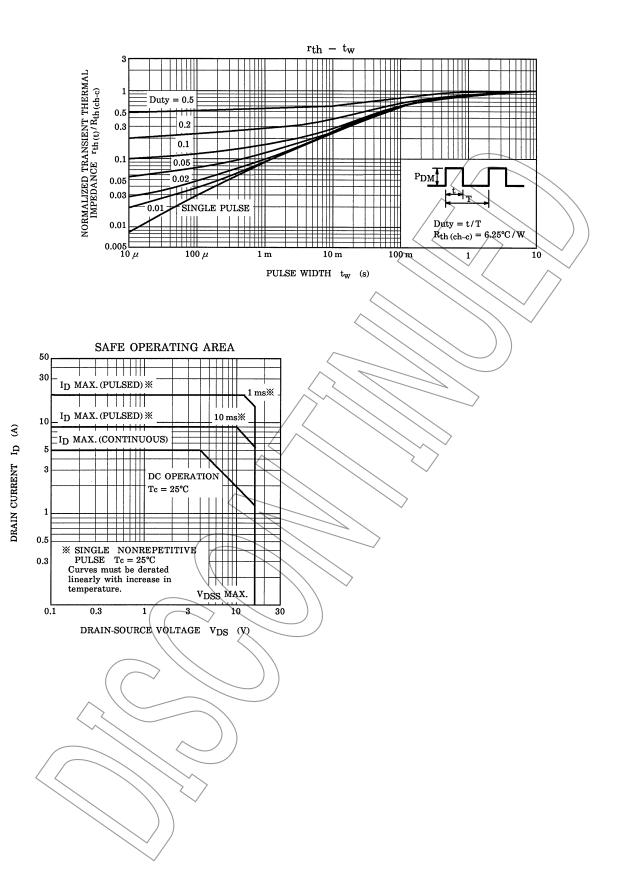
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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